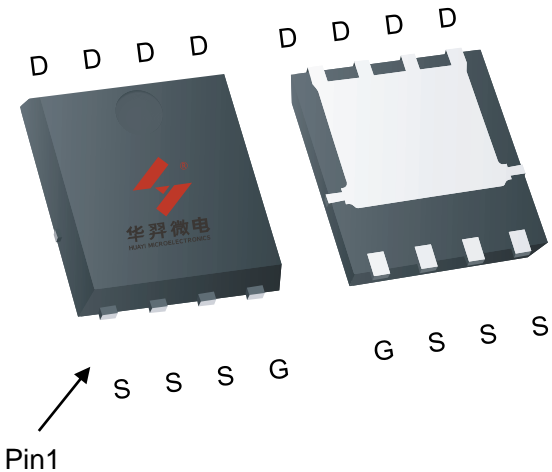


Single N-Channel Enhancement Mode MOSFET

**Feature**

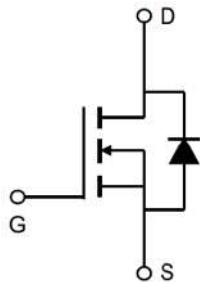
- 40V/78A  
 $R_{DS(ON)} = 5.3\text{ m}\Omega$  (typ.) @  $V_{GS} = 10\text{V}$
- 100% Avalanche Tested
- 100% DVDS
- Reliable and Rugged
- MSL1 up to 260°C Peak Reflow
- AEC-Q101 Qualified
- 175°C operating temperature
- Halogen Free and Green Devices Available  
(RoHS Compliant)

**Pin Description**




**Applications**

- DC-DC converter for H.E.V. (hybrid electric vehicle)
- Battery Disconnect Switch
- Load Disconnect Power Stage
- Automotive Applications



Single N-Channel MOSFET

**Ordering and Marking Information**

 C2 HYA060N04 XYMXXXXXX	Package Code C2: PDFN8L(5x6)  Date Code XYMXXXXXX
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Note: HUAYI lead-free products contain molding compounds/die attach materials and 100% matte tin plateTermination finish; which are fully compliant with RoHS. HUAYI lead-free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines “Green” to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr

-oduct and/or to this document at any time without notice.

## Absolute Maximum Ratings

Symbol	Parameter		Rating	Unit
Common Ratings (Tc=25°C Unless Otherwise Noted)				
V <sub>DSS</sub>	Drain-Source Voltage		40	V
V <sub>GSS</sub>	Gate-Source Voltage		+20 / -20	V
T <sub>J</sub>	Maximum Junction Temperature		-55 to 175	°C
T <sub>STG</sub>	Storage Temperature Range			°C
I <sub>S</sub>	Source Current-Continuous(Body Diode)	Tc=25°C	78	A
Mounted on Large Heat Sink				
I <sub>DM</sub>	Pulsed Drain Current *	Tc=25°C	312	A
I <sub>D</sub>	Continuous Drain Current	Tc=25°C	78	A
		Tc=125°C	44	A
P <sub>D</sub>	Maximum Power Dissipation	Tc=25°C	74	W
		Tc=100°C	37	W
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case		2.03	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient **		80	°C/W
E <sub>AS</sub>	SinglePulsed-Avalanche Energy ***	L=0.3mH	76	mJ

Note: \* Repetitive rating; pulse width limited by max.junction temperature.  
 \*\* Surface mounted on FR-4 board.  
 \*\*\* Limited by T<sub>Jmax</sub>, starting T<sub>J</sub>=25°C, L = 0.3mH, V<sub>DS</sub>=32V., V<sub>GS</sub>=10V.

## Electrical Characteristics(Tc =25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	HYA060N04NS1			Unit
			Min	Typ.	Max	
Static Characteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA	40	-	-	V
I <sub>DSS</sub>	Drain-to-Source Leakage Current	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V	-	-	1	μA
		T <sub>J</sub> =100°C	-	-	50	μA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA	2.0	3.0	4.0	V
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
R <sub>DS(ON)*</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10V, I <sub>DS</sub> =20A	-	5.3	6.5	mΩ
Diode Characteristics						
V <sub>SD</sub> *	Diode Forward Voltage	I <sub>SD</sub> =20A, V <sub>GS</sub> =0V	-	0.86	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>SD</sub> =20A, dI <sub>SD</sub> /dt=100A/μs	-	17.4	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	9.5	-	nC

**Electrical Characteristics (Cont.)** (T<sub>c</sub> =25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	HYA060N04NS1			Unit
			Min	Typ.	Max	
Dynamic Characteristics						
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> =0V,V <sub>DS</sub> =0V, F=500kHz	-	2.8	-	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, Frequency=500kHz	-	962	-	pF
C <sub>oss</sub>	Output Capacitance		-	218	-	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	20	-	
t <sub>d(ON)</sub>	Turn-on Delay Time	V <sub>DD</sub> =20V,R <sub>G</sub> =2.5Ω, I <sub>DS</sub> =20A,V <sub>GS</sub> =10V	-	11.2	-	ns
T <sub>r</sub>	Turn-on Rise Time		-	42.8	-	
t <sub>d(OFF)</sub>	Turn-off Delay Time		-	20.8	-	
T <sub>f</sub>	Turn-off Fall Time		-	28.3	-	
Gate Charge Characteristics						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =32V, V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	14.7	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	5.6	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	2.1	-	
V <sub>plateau</sub>	Gate plateau voltage		-	5.0	-	V

Note: \*Pulse test, pulse width ≤ 300us, duty cycle ≤ 2%

## Typical Operating Characteristics

Figure 1: Power Dissipation

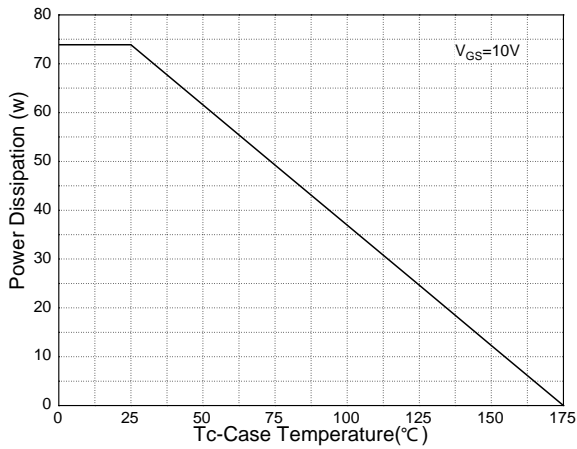


Figure 2: Drain Current

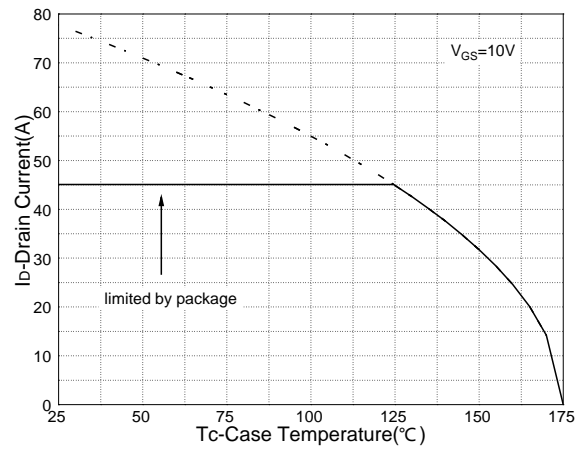


Figure 3: Safe Operation Area

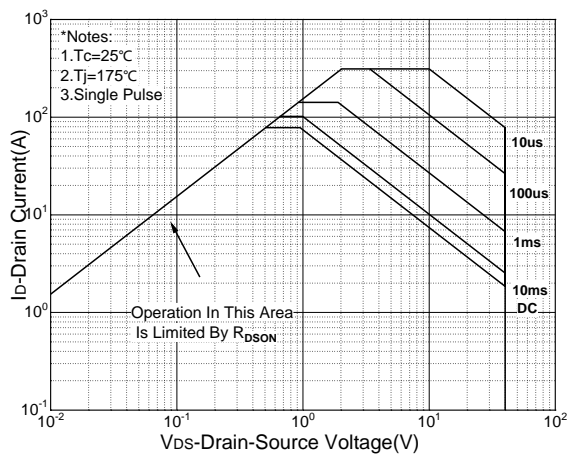


Figure 4: Thermal Transient Impedance

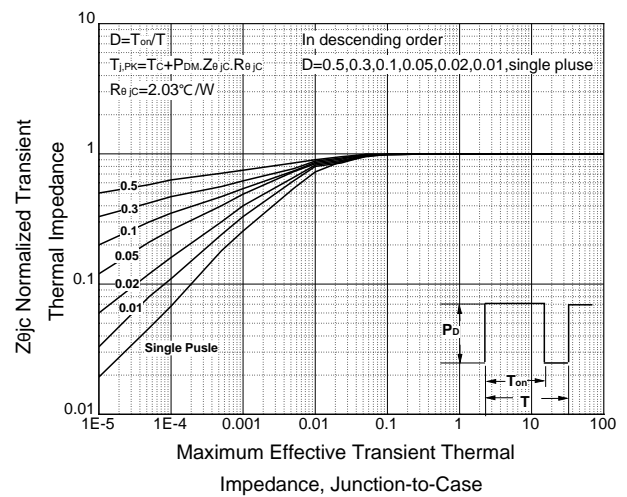


Figure 5: Output Characteristics

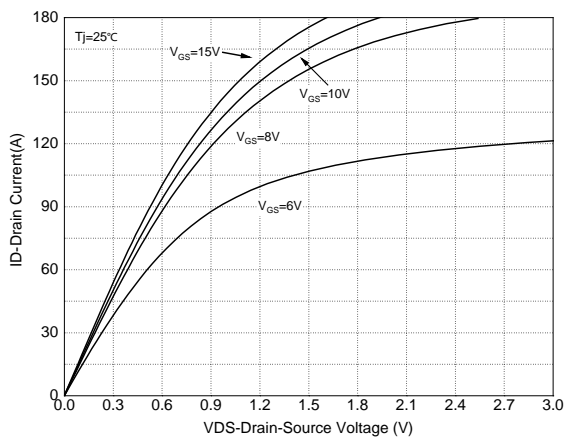
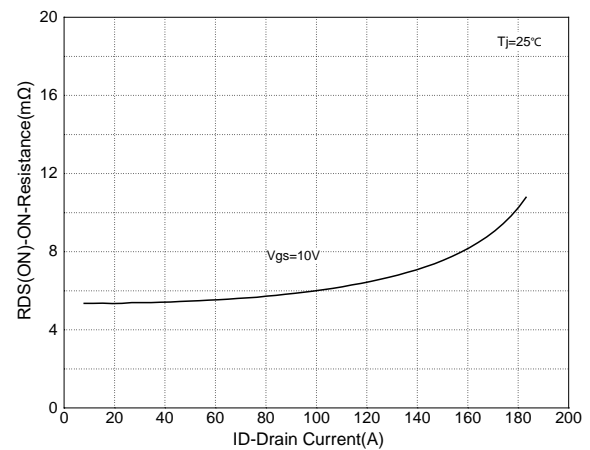
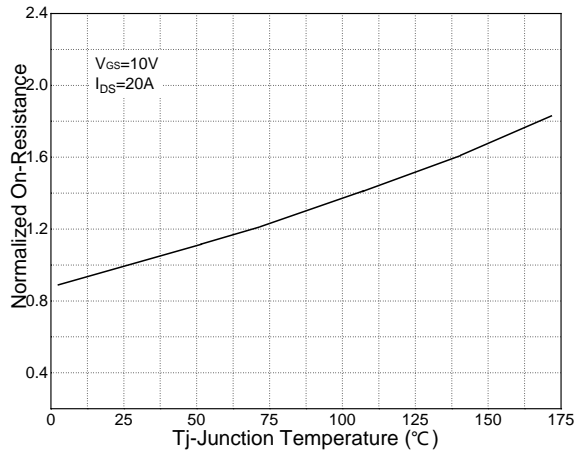


Figure 6: Drain-Source On Resistance

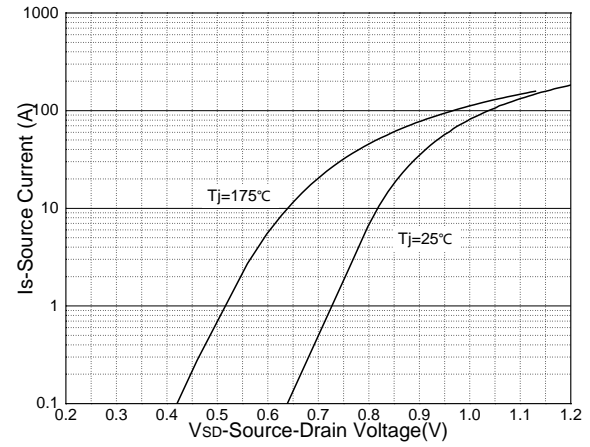


## Typical Operating Characteristics(Cont.)

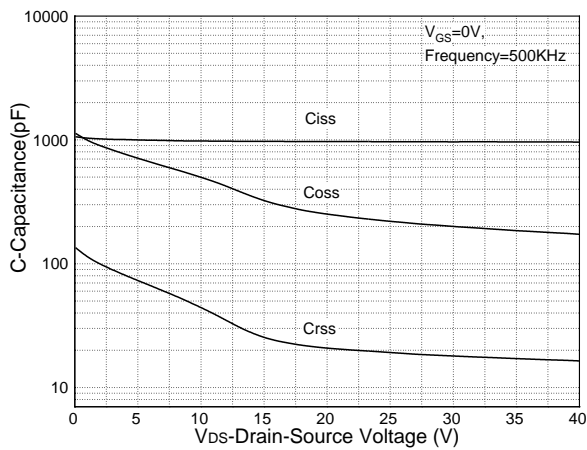
**Figure 7: On-Resistance vs. Temperature**



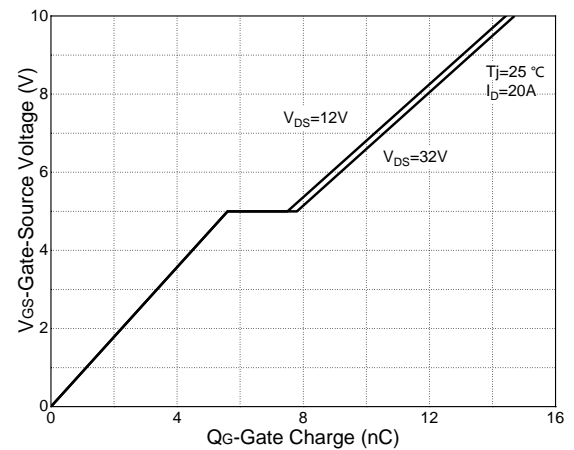
**Figure 8: Source-Drain Diode Forward**



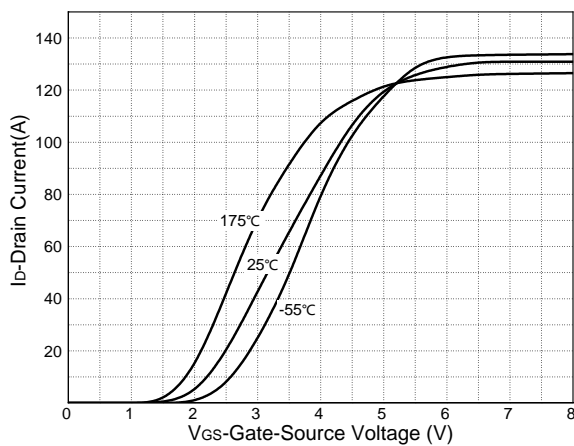
**Figure 9: Capacitance Characteristics**



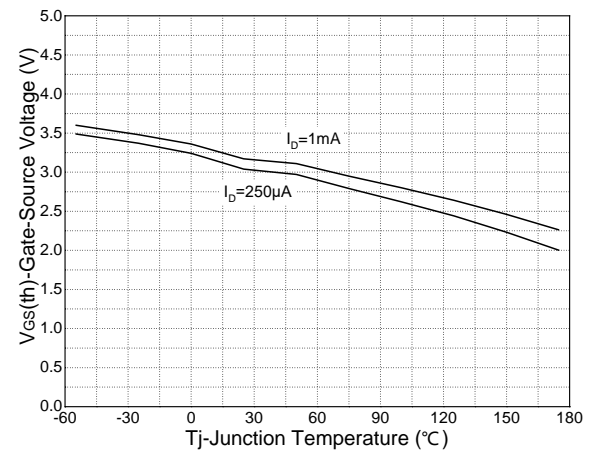
**Figure 10: Gate Charge Characteristics**



**Figure 11: Transfer Characteristics**



**Figure 12: Gate Threshold Voltage**



# HYA060N04NS1C2

## Typical Operating Characteristics(Cont.)

Figure 13: Drain-Source Breakdown

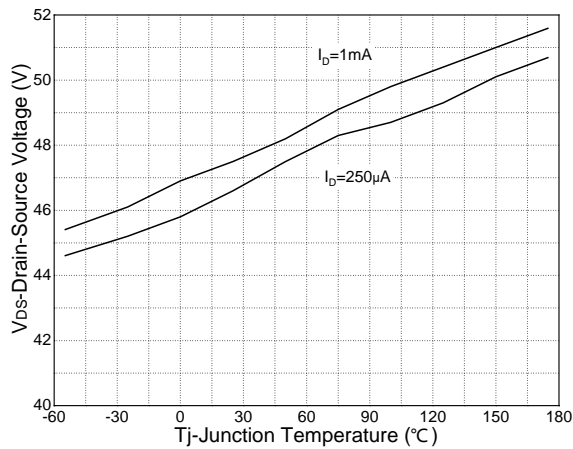


Figure 14:  $R_{dson}$  vs. Gate Voltage

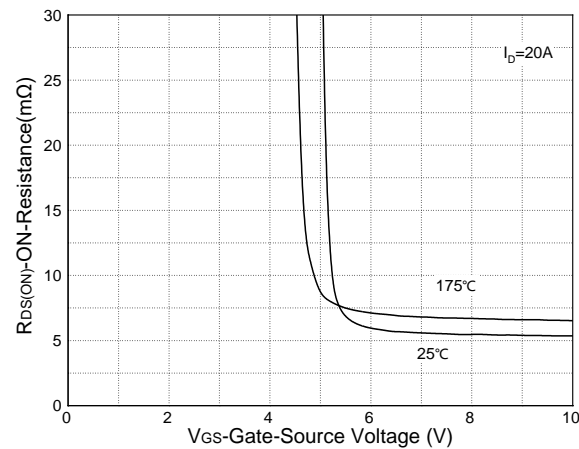
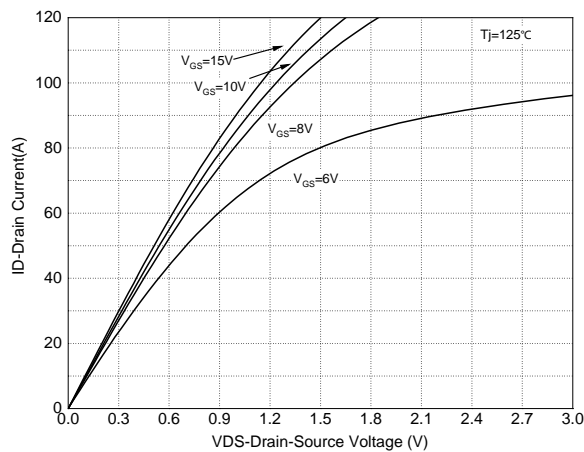
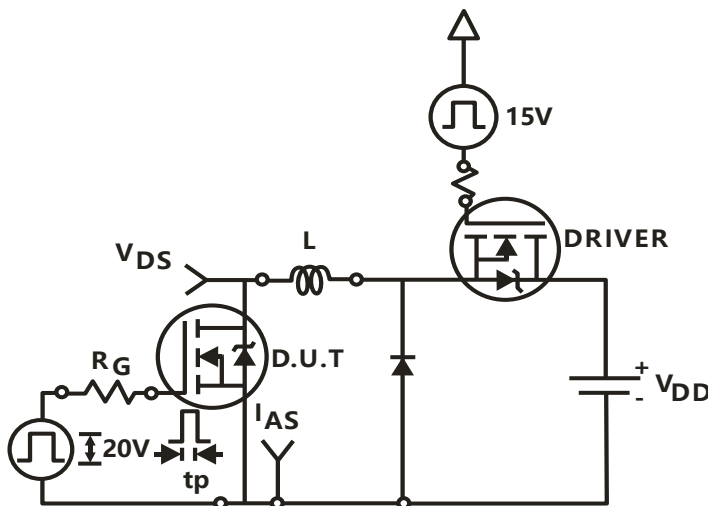


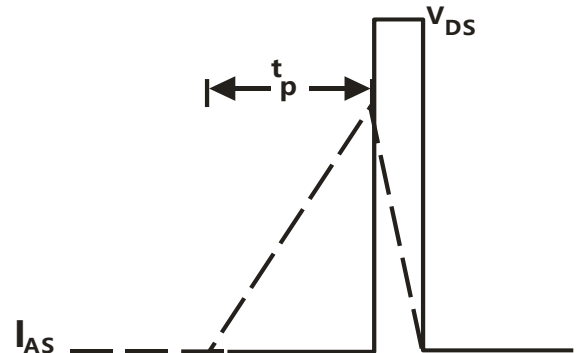
Figure 15: Output Characteristics (125°C)



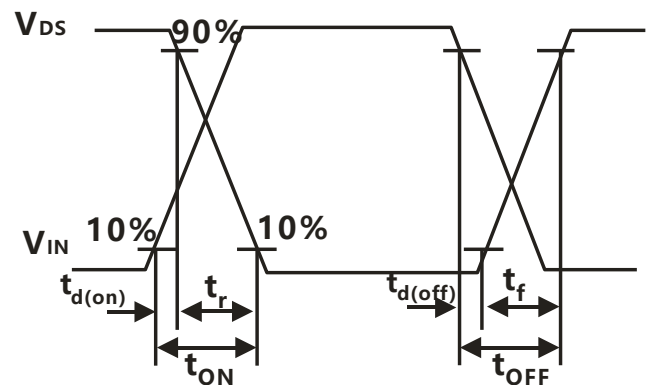
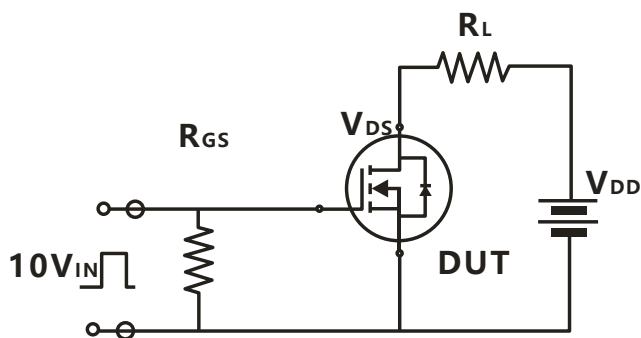
## Avalanche Test Circuit and Waveforms



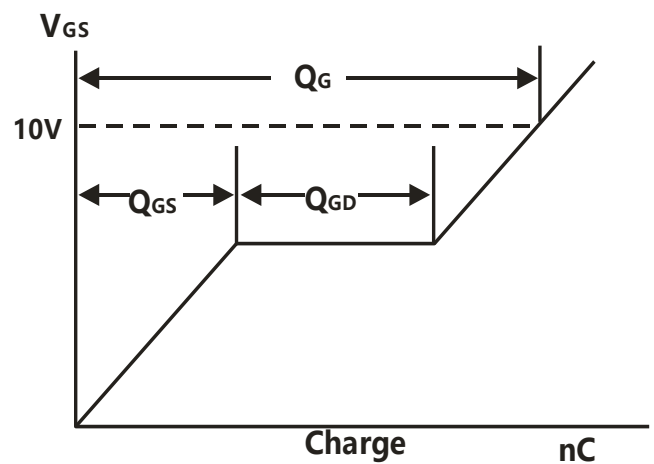
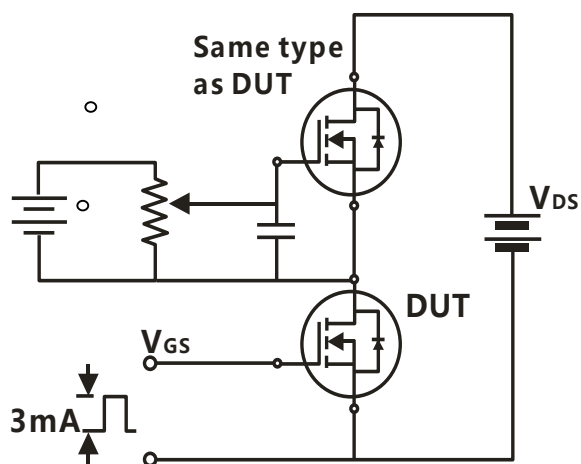
$$E_{AS} = \frac{1}{2} L I_{AS}^2$$



## Switching Time Test Circuit and Waveforms



## Gate Charge Test Circuit and Waveforms



# HYA060N04NS1C2

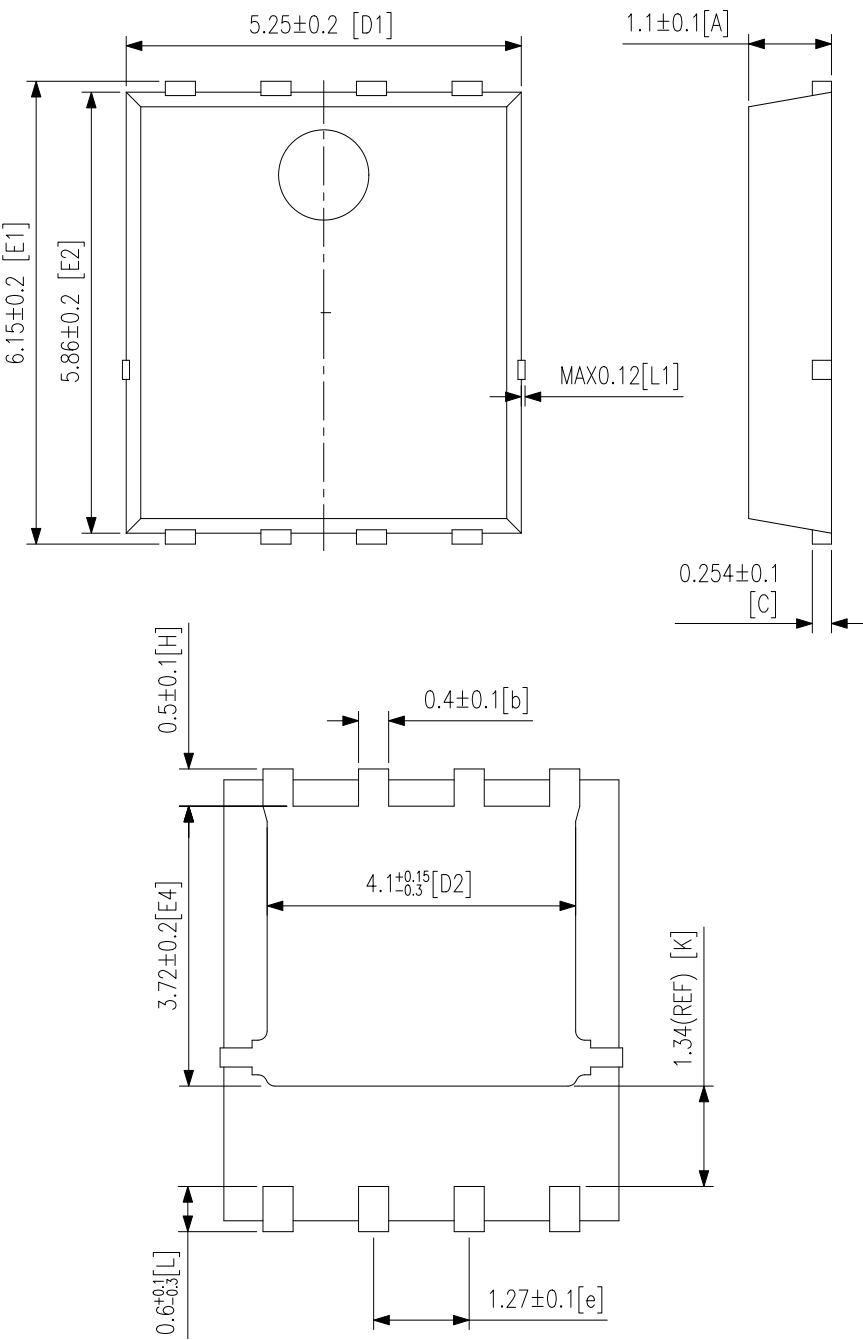
## Device Per Unit

Package Type	Unit	Quantity
PDFN8L(5x6)	Reel	5000

## Package Information

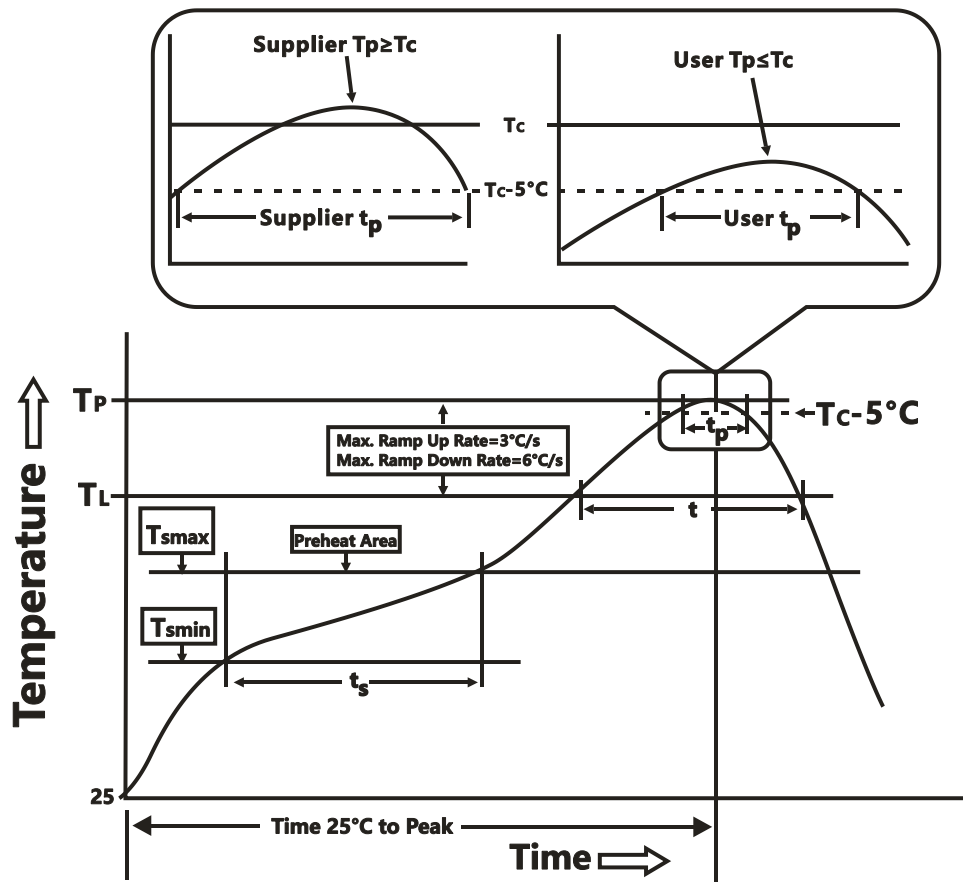
PDFN8L(5x6)

(unit:mm)





## Classification Profile



## Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
<b>Preheat &amp; Soak</b>		
Temperature min ( $T_{smin}$ )	100 °C	150 °C
Temperature max ( $T_{smax}$ )	150 °C	200 °C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 seconds	60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_P$ )	3 °C/second max.	3°C/second max.
Liquidous temperature ( $T_L$ )	183 °C	217 °C
Time at liquidous ( $t_l$ )	60-150 seconds	60-150 seconds
Peak package body Temperature ( $T_p$ )*	See Classification Temp in table 1	See Classification Temp in table 2
Time ( $t_p$ )** within $5^\circ\text{C}$ of the specified classification temperature ( $T_c$ )	20** seconds	30** seconds
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6 °C/second max.	6 °C/second max.
Time $25^\circ\text{C}$ to peak temperature	6 minutes max.	8 minutes max.
*Tolerance for peak profile Temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum.		
** Tolerance for time at peak profile temperature ( $t_p$ ) is defined as a supplier minimum and a user maximum.		

Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2.Pb-free Process – Classification Temperatures (Tc)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> ≥2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

## Reliability Test Program

Test item	Method	Description
PCT	JESD22-A102	121°C,100%RH, 96hours, 205KPa
TCT	JESD22-A104	250/500/1000 Cycles, -55°C~150°C
HTRB	JESD22-A108B	168/500/1000 Hrs, 100% BV <sub>DSS</sub> @ 175°C
HTGB	JESD22-A108B	168/500/1000 Hrs, 100%V <sub>gs</sub> @ 175°C
BHAST	JESD22-A110D	130°C, 85%RH, 230KPA;U=32V
IOL	MIL-STD-750	Ta=25°C,ΔTj≥100°C, Ton/Toff 2min , 15000cycles

### Customer Service

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